# LNJ808R8ERA

Surface Mounting Chip LED

SS Type

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	30	mW	
Forward current	I <sub>F</sub>	10	mA	
Pulse forward current *	I <sub>FP</sub>	50	mA	
Reverse voltage	V <sub>R</sub>	3	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-40 to +100	°C	

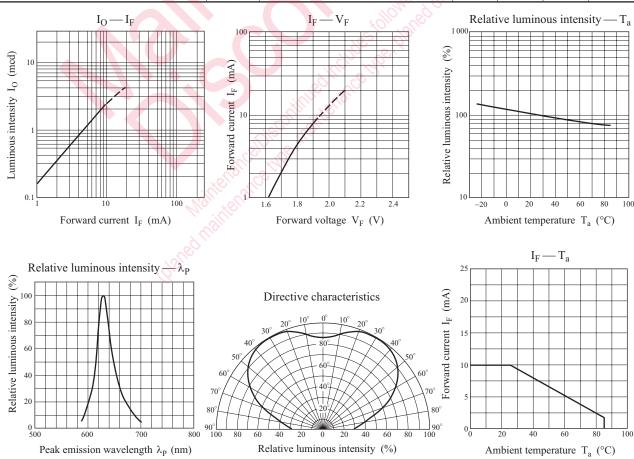
Lighting Color

• Orange

Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

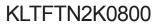
#### Electro-Optical Characteristics $T_a = 25^{\circ}C$

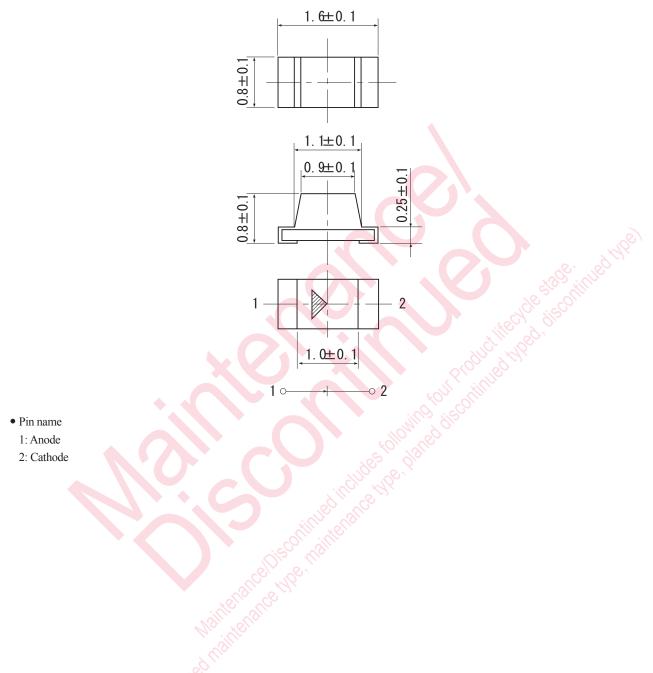
1 d					X	0-2 <u></u>	
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_F = 5 \text{ mA}$		0.4	\$1.1 8	P	mcd
Reverse current	I <sub>R</sub>	$V_R = 3 V$			1000	10	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		(00°, 8°	1.8	2.4	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 5 \text{ mA}$	illes and	din	630		nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$	in Oni		40		nm



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Package (Unit: mm)





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